

## General Purpose Transistors NPN Silicon

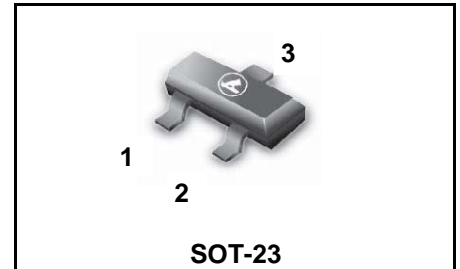
### ●FEATURES

- 1) We declare that the material of product compliance with RoHS requirements.
- 2) S- Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable.

### ●DEVICE MARKING AND RESISTOR VALUES

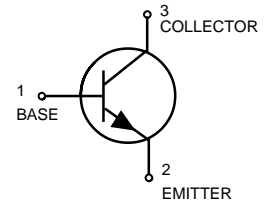
Device	Marking	Shipping
LMBT3904LT1G	1AM	3000/Tape&Reel
LMBT3904LT3G	1AM	10000/Tape&Reel

### LMBT3904LT1G S-LMBT3904LT1G



### ●MAXIMUM RATINGS(Ta = 25°C)

Parameter	Symbol	Limits	Unit
Collector–Emitter Voltage	V <sub>CEO</sub>	40	Vdc
Collector–Base Voltage	V <sub>CBO</sub>	60	Vdc
Emitter–Base Voltage	V <sub>EBO</sub>	6	Vdc
Collector Current — Continuous	I <sub>C</sub>	200	mAdc



### ●THERMAL CHARACTERISTICS

Total Device Dissipation, FR-5 Board (Note 1) @ T <sub>A</sub> = 25°C Derate above 25°C	P <sub>D</sub>	225	mW
		1.8	mW/°C
Thermal Resistance, Junction–to–Ambient(Note 1)	R <sub>θJA</sub>	556	°C/W
Total Device Dissipation, Alumina Substrate (Note 2) @ T <sub>A</sub> = 25°C Derate above 25°C	P <sub>D</sub>	300	mW
		2.4	mW/°C
Thermal Resistance, Junction–to–Ambient(Note 2)	R <sub>θJA</sub>	417	°C/W
Junction and Storage temperature	T <sub>J</sub> ,T <sub>stg</sub>	-55 ~ +150	°C

1. FR-5 = 1.0×0.75×0.062 in.

2. Alumina = 0.4×0.3×0.024 in. 99.5% alumina.

**LMBT3904LT1G,S-LMBT3904LT1G**
**● ELECTRICAL CHARACTERISTICS (Ta= 25°C)**
**OFF CHARACTERISTICS**

Characteristic	Symbol	Min.	Typ.	Max.	Unit
Collector–Emitter Breakdown Voltage (I <sub>C</sub> = 1.0 mA <sub>dc</sub> , I <sub>B</sub> = 0)	V <sub>BR(CEO)</sub>	40	–	–	V
Collector–Base Breakdown Voltage (I <sub>C</sub> = 10 μA <sub>dc</sub> , I <sub>E</sub> = 0)	V <sub>BR(CBO)</sub>	60	–	–	V
Emitter–Base Breakdown Voltage (I <sub>E</sub> = 10 μA <sub>dc</sub> , I <sub>C</sub> = 0)	V <sub>BR(EBO)</sub>	6	–	–	V
Collector Cutoff Current (V <sub>CE</sub> = 30 V <sub>dc</sub> , V <sub>EB</sub> = 3.0V <sub>dc</sub> )	I <sub>CEX</sub>	–	–	50	nA
Base Cutoff Current (V <sub>CE</sub> = 30 V <sub>dc</sub> , V <sub>EB</sub> = 3.0 V <sub>dc</sub> )	I <sub>BL</sub>	–	–	50	nA

**ON CHARACTERISTICS (Note 3.)**

DC Current Gain (I <sub>C</sub> = 0.1 mA <sub>dc</sub> , V <sub>CE</sub> = 1.0 V <sub>dc</sub> ) (I <sub>C</sub> = 1.0 mA <sub>dc</sub> , V <sub>CE</sub> = 1.0 V <sub>dc</sub> ) (I <sub>C</sub> = 10 mA <sub>dc</sub> , V <sub>CE</sub> = 1.0 V <sub>dc</sub> ) (I <sub>C</sub> = 50 mA <sub>dc</sub> , V <sub>CE</sub> = 1.0 V <sub>dc</sub> ) (I <sub>C</sub> = 100 mA <sub>dc</sub> , V <sub>CE</sub> = 1.0 V <sub>dc</sub> )	h <sub>FE</sub>	40 70 100 60 30	– – – – –	– – 300 – –	
Collector–Emitter Saturation Voltage(3) (I <sub>C</sub> = 10 mA <sub>dc</sub> , I <sub>B</sub> = 1.0 mA <sub>dc</sub> ) (I <sub>C</sub> = 50mA <sub>dc</sub> , I <sub>B</sub> = 5.0 mA <sub>dc</sub> )	V <sub>CE(sat)</sub>	– –	– –	0.2 0.3	V
Base–Emitter Saturation Voltage (I <sub>C</sub> = 10 mA <sub>dc</sub> , I <sub>B</sub> = 1.0 mA <sub>dc</sub> ) (I <sub>C</sub> = 50mA <sub>dc</sub> , I <sub>B</sub> = 5.0 mA <sub>dc</sub> )	V <sub>BE(sat)</sub>	0.65 –	– –	0.85 0.95	V

**SMALL–SIGNAL CHARACTERISTICS**

Characteristic	Symbol	Min.	Typ.	Max.	Unit
Current–Gain — Bandwidth Product (I <sub>C</sub> = 10mA <sub>dc</sub> , V <sub>CE</sub> = 20V <sub>dc</sub> , f = 100MHz)	f <sub>T</sub>	300	–	–	MHz
Output Capacitance (V <sub>CB</sub> = 5.0 V <sub>dc</sub> , I <sub>E</sub> = 0, f = 1.0 MHz)	C <sub>obo</sub>	–	–	4	pF
Input Capacitance (V <sub>EB</sub> = 0.5 V <sub>dc</sub> , I <sub>C</sub> = 0, f = 1.0 MHz)	C <sub>ibo</sub>	–	–	8	pF
Input Impedance (V <sub>CE</sub> = 10 V <sub>dc</sub> , I <sub>C</sub> = 1.0 mA <sub>dc</sub> , f = 1.0 kHz)	h <sub>ie</sub>	1	–	10	kΩ
Voltage Feedback Ratio (V <sub>CE</sub> = 10 V <sub>dc</sub> , I <sub>C</sub> = 1.0 mA <sub>dc</sub> , f = 1.0 kHz)	h <sub>re</sub>	0.5	–	8	X 10 <sup>-4</sup>
Small–Signal Current Gain (V <sub>CE</sub> = 10 V <sub>dc</sub> , I <sub>C</sub> = 1.0 mA <sub>dc</sub> , f = 1.0 kHz)	h <sub>fe</sub>	100	–	400	
Output Admittance (V <sub>CE</sub> = 10 V <sub>dc</sub> , I <sub>C</sub> = 1.0 mA <sub>dc</sub> , f = 1.0 kHz)	h <sub>oe</sub>	1	–	40	μmhos
Noise Figure (V <sub>CE</sub> =5V, I <sub>C</sub> =100μA, R <sub>S</sub> =1.0kΩ, f=1.0kHz)	NF	–	–	5	dB

3. Pulse Test: Pulse Width &lt;300 μs, Duty Cycle &lt;2.0%.

## LMBT3904LT1G,S-LMBT3904LT1G

●ELECTRICAL CHARACTERISTICS (Ta= 25°C)

SWITCHING CHARACTERISTICS

Delay Time	(V <sub>CC</sub> = 3.0 Vdc, V <sub>BE</sub> = -0.5 Vdc, I <sub>C</sub> = 10 mA, I <sub>B1</sub> = 1.0 mA)	t <sub>d</sub>	-	-	35	ns
Rise Time		t <sub>r</sub>	-	-	35	
Storage Time	(V <sub>CC</sub> = 3.0 Vdc, I <sub>C</sub> = 10 mA, I <sub>B1</sub> = I <sub>B2</sub> = 1.0 mA)	t <sub>s</sub>	-	-	200	
Fall Time		t <sub>f</sub>	-	-	50	

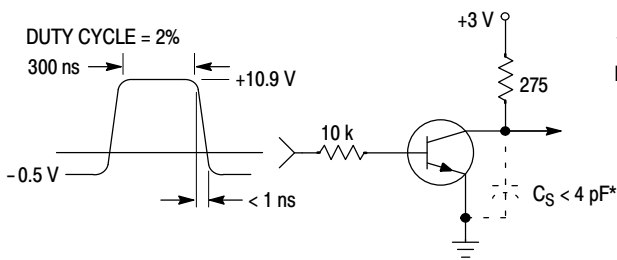


Figure 1. Delay and Rise Time Equivalent Test Circuit

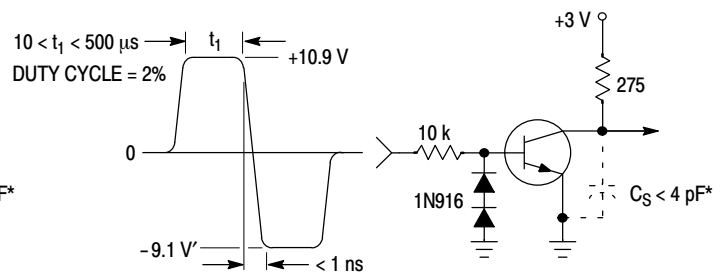


Figure 2. Storage and Fall Time Equivalent Test Circuit

\* Total shunt capacitance of test jig and connectors

## LMBT3904LT1G,S-LMBT3904LT1G

### ELECTRICAL CHARACTERISTICS CURVES

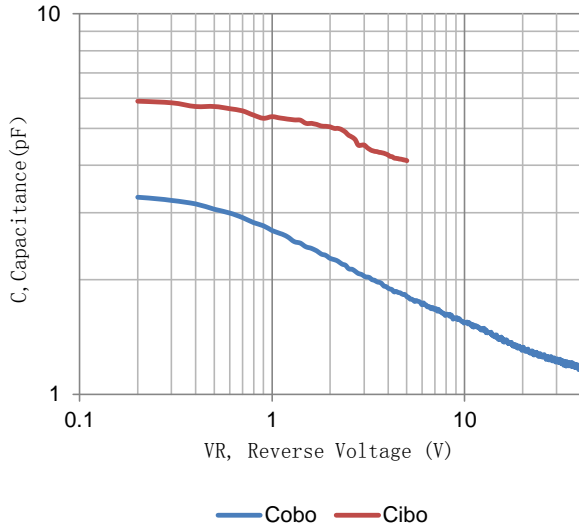


Figure 3. Capacitance

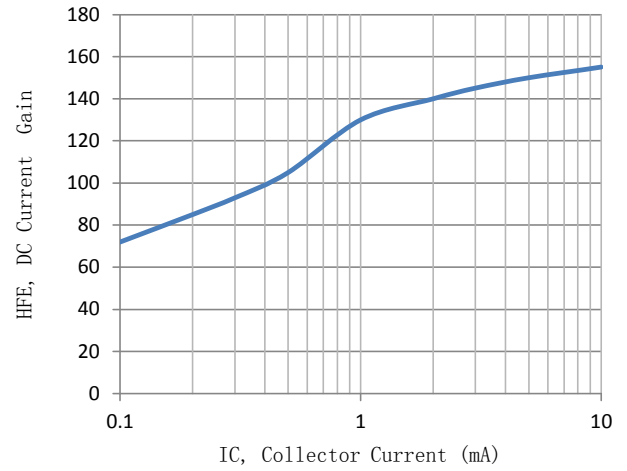


Figure 4. Current Gain

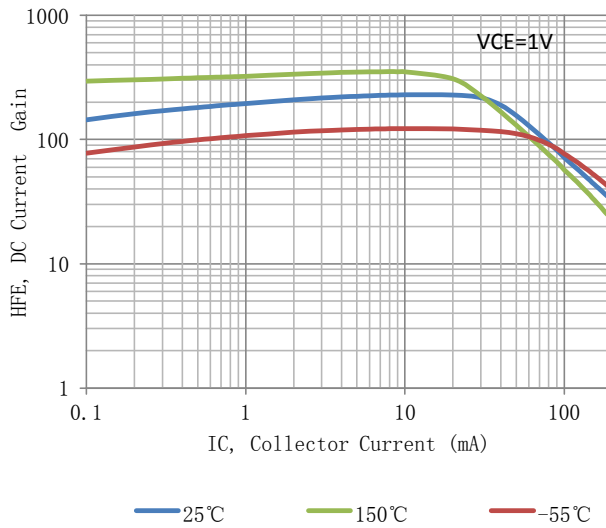


Figure 5. DC Current Gain

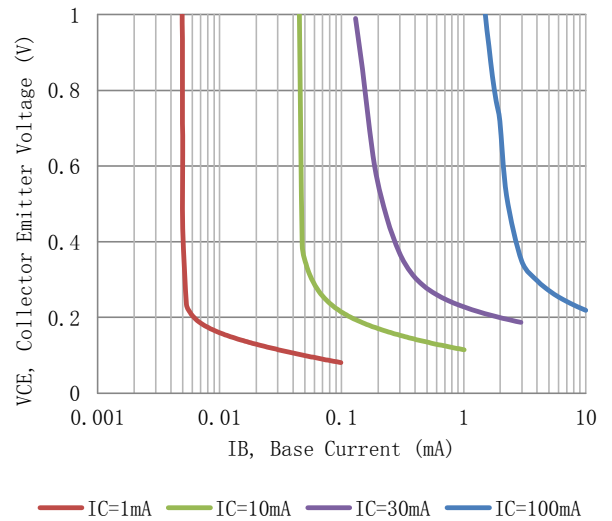


Figure 6. Collector Saturation Region

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### ELECTRICAL CHARACTERISTICS CURVES

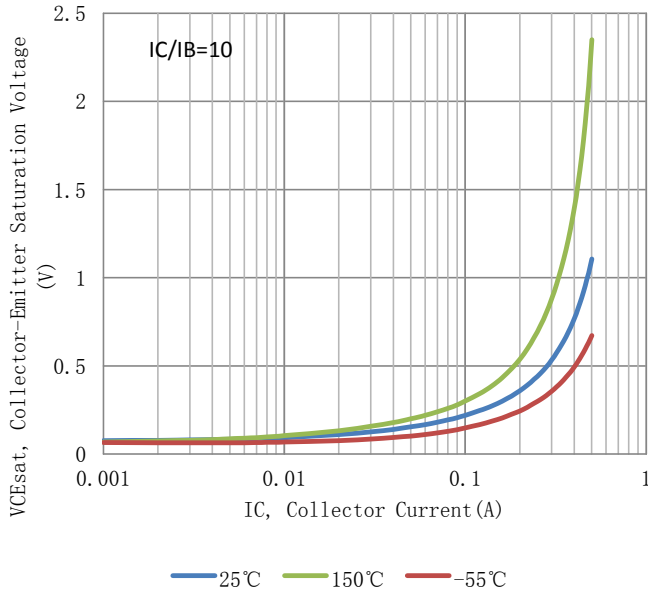


Figure 7.  $V_{CE(sat)}$  vs  $I_C$

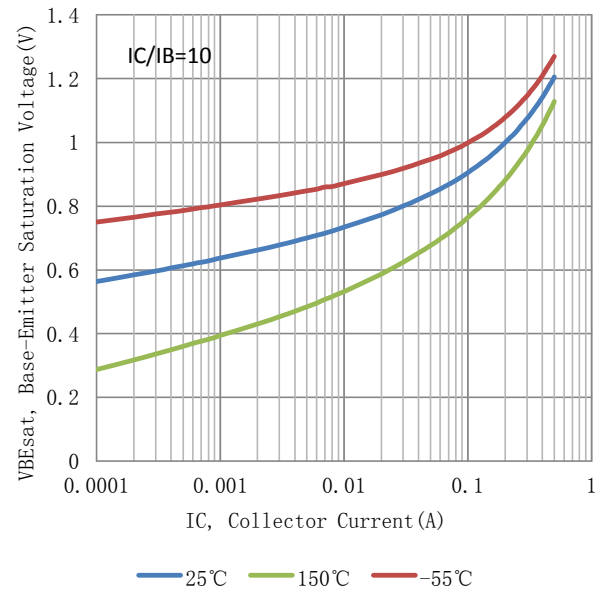


Figure 8.  $V_{BE(sat)}$  vs  $I_C$

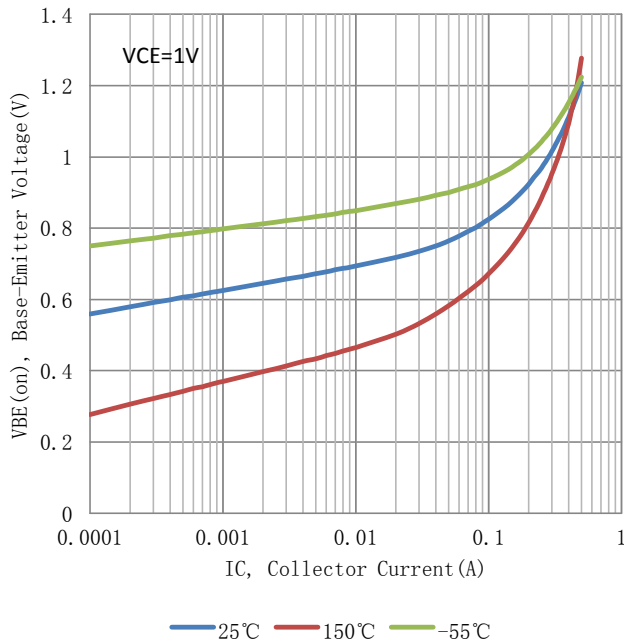
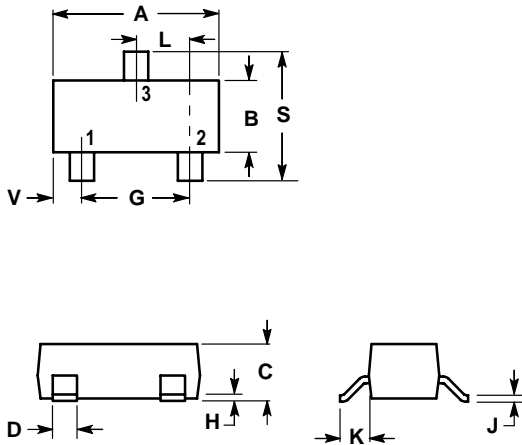


Figure 9.  $V_{BE(on)}$  vs  $I_C$

# LMBT3904LT1G,S-LMBT3904LT1G

## SOT-23

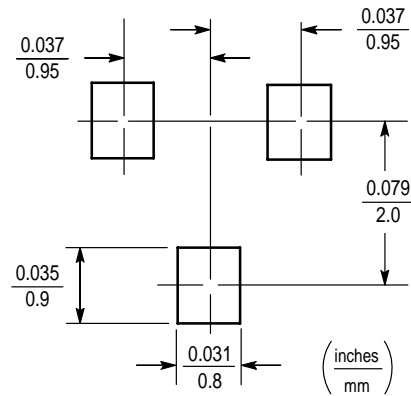


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.1102	0.1197	2.80	3.04
B	0.0472	0.0551	1.20	1.40
C	0.0350	0.0440	0.89	1.11
D	0.0150	0.0200	0.37	0.50
G	0.0701	0.0807	1.78	2.04
H	0.0005	0.0040	0.013	0.100
J	0.0034	0.0070	0.085	0.177
K	0.0140	0.0285	0.35	0.69
L	0.0350	0.0401	0.89	1.02
S	0.0830	0.1039	2.10	2.64
V	0.0177	0.0236	0.45	0.60

- PIN 1. BASE  
 2. EMITTER  
 3. COLLECTOR



单击下面可查看定价，库存，交付和生命周期等信息

[>>LRC\(乐山无线电\)](#)